Switch-mode Power Rectifier

MUR550APFG, MURD550PFG, MUR550PFG, MURF550PFG, NRVUD550PFT4G, NRVUD550PFT4G-VF01

These state-of-the-art devices are designed for power factor correction in discontinuous and critical conduction mode.

Features

- 520 V Rating Meets 80% Derating Requirements of Major OEMs
- Low Forward Voltage Drop
- Low Leakage
- Ultrafast 95 Nanosecond Recovery Time
- Reduces Forward Conduction Loss
- NRVUD Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

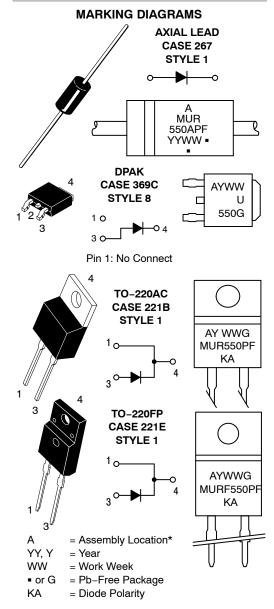
- DCM PFC Designs
- Switching Power Supplies
- Power Inverters
- Mechanical Characteristics:
- Case: Epoxy, Molded
- Epoxy Meets UL 94 V-0 @ 0.125 in
- Weight: MUR550APFG: 1.1 Gram (Approximately) MURD550PFG, NRVUD550PFT4G, NRVUD550PFT4G–VF01: 0.4 Gram (Approximately) MUR550PFG, MURF550PFG: 1.9 Gram (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds



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ULTRAFAST RECTIFIER 5.0 AMPERES, 520 VOLTS



*The Assembly Location Code (A) is front side optional. In cases where the Assembly Location is stamped in the package bottom (molding ejecter pin), the front side assembly code may be blank.

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
MUR550APFG	Axial	500 Units/Bag
MUR550APFRLG	Axial	1,500 Tape & Reel
MURD550PFT4G	DPAK (Pb-Free)	2,500 Tape & Reel
NRVUD550PFT4G*	DPAK (Pb–Free)	2,500 Tape & Reel
NRVUD550PFT4G-VF01*	DPAK (Pb–Free)	50 Units / Rail
MUR550PFG	TO-220AC (Pb-Free)	50 Units / Rail
MURF550PFG	TO-220FP (Pb-Free)	50 Units / Rail

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

*NRVUD Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	520	V
Average Rectified Forward Current (Rated V_R) $T_C = 65^{\circ}C$ MUR550APFG, NRVUD550PFT4G-VF01 MURD550PFG, NRVUD550PFT4G, MURD550PFG, MURF550PFG, MURF550PFG	I _{F(AV)}	5.0 5.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, 60 Hz) MUR550APFG NRVUD550PFT4G, NRVUD550PFT4G-VF01, MURD550PFG MUR550PFG, MURF550PFG	I _{FSM}	85 75 100	A
Operating Junction Temperature Range	ТJ	-65 to +175	°C
Storage Temperature Range	T _{stg}	-65 to +175	°C
ESD Ratings: Machine Model = C Human Body Model = 3B	ESD	> 400 > 8000	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Note 1) MURD550PG, MUR550PFG, NRVUD550PFT4G, NRVUD550PFT4G-VF01 MURF550PFG	R _{θJC}	2.8 5.75	°C/W
Thermal Resistance, Junction-to-Ambient MUR550APFG NRVUD550PFT4G, NRVUD550PFT4G-VF01, MURD550PFG (Note 3), MURF550PFG	$R_{ heta JA}$	Note 2 62 75	°C/W

1. Rating applies when surface mounted on the minimum pad sizes recommended.

2. See Note 2, Ambient Mounting Data.

3. 1 inch square pad size on FR4 board.

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage Drop (Note 4) (I _F = 5.0 A, T _J = 25°C) (I _F = 5.0 A, T _J = 150°C)	V _F	1.15 0.98	V
Maximum Instantaneous Reverse Current (Note 4) ($V_R = 520 \text{ V}, T_J = 25^{\circ}\text{C}$) ($V_R = 520 \text{ V}, T_J = 150^{\circ}\text{C}$)	I _R	5.0 400	μΑ
Maximum Reverse Recovery Time (I _F = 1.0 A, di/dt = 50 A/ μ s, V _R = 30 V, T _J = 25°C)	t _{rr}	95	ns

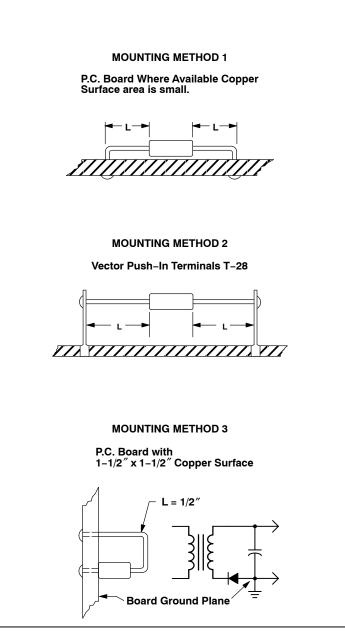
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
4. Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%.

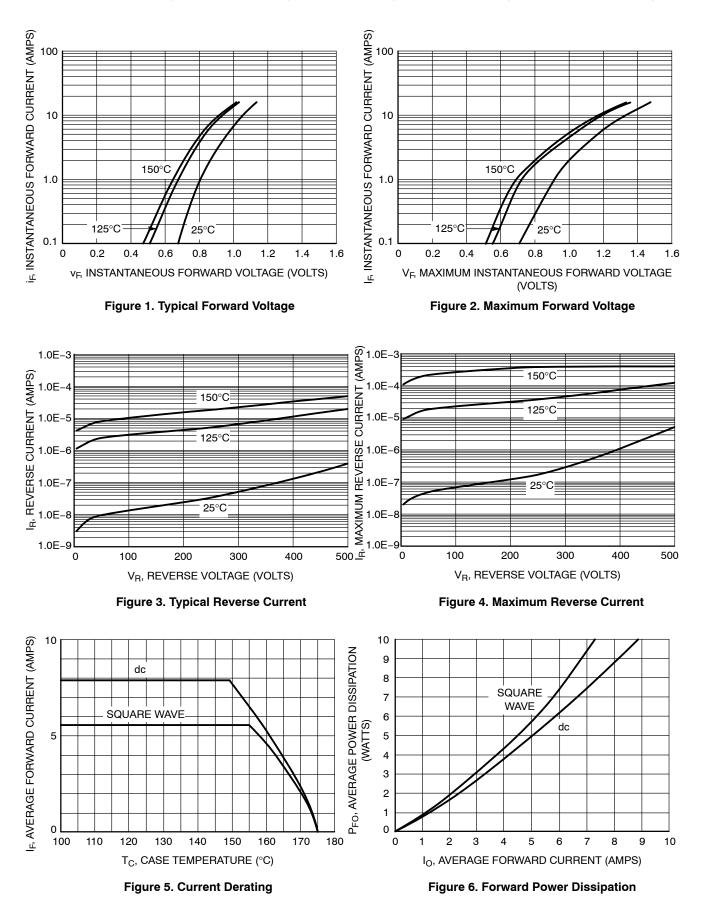
NOTE 2 — AMBIENT MOUNTING DATA

Data shown for thermal resistance junction-to-ambient $(R_{\theta JA})$ for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

TYPICAL VALUES FOR $\textbf{R}_{\theta \textbf{JA}}$ IN STILL AIR

Mount	Mounting		Lead Length, L (IN)			
Metho	bd	1/8	1/4	1/2	3/4	Units
1		50	51	53	55	°C/W
2	R _{0JA}	58	59	61	63	°C/W
3			2	.8		°C/W





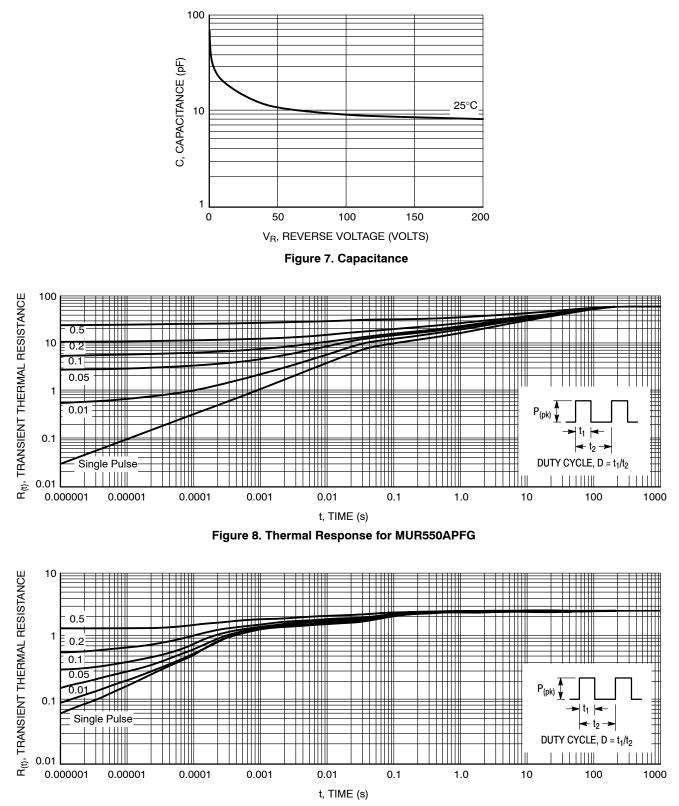
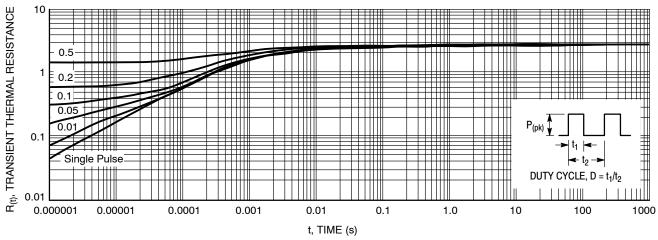


Figure 9. Thermal Response for MURD550PFG, NRVUD550PFT4G, NRVUD550PFT4G-VF01





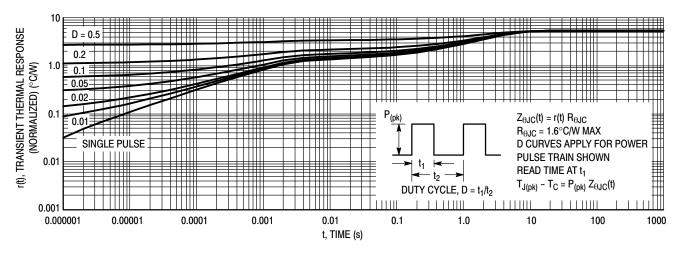


Figure 11. Thermal Response, (MURF550PFG) Junction-to-Case ($R_{\theta JC}$)

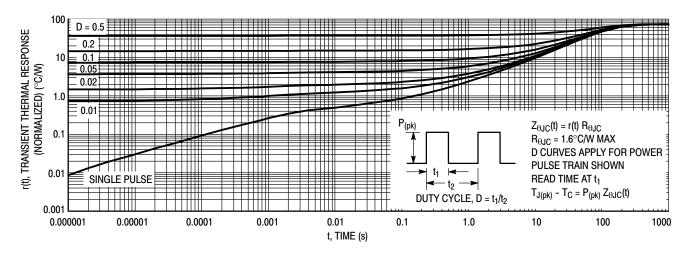


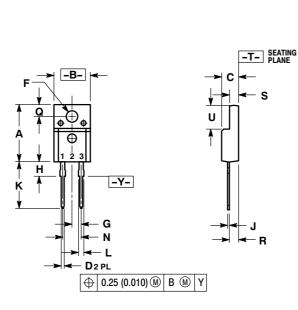
Figure 12. Thermal Response, (MURF550PFG) Junction-to-Ambient ($R_{\theta JA}$)

DATE 21 JAN 2008





SCALE 1:1



TO-220 FULLPAK, 2-LEAD CASE 221E-01 ISSUE A

	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.617	0.633	15.67	16.07
В	0.392	0.408	9.96	10.36
С	0.177	0.193	4.50	4.90
D	0.024	0.039	0.60	1.00
F	0.121	0.129	3.08	3.28
G	0.100) BSC	2.54 BSC	
н	0.117	0.133	2.98	3.38
J	0.018	0.025	0.45	0.64
К	0.499	0.562	12.68	14.27
L	0.045	0.060	1.14	1.5
Ν	0.200) BSC	5.08 BSC	
Q	0.122	0.138	3.10	3.50
R	0.101	0.117	2.56	2.9
S	0.092	0.108	2.34	2.74
U	0.255	0.271	6.48	6.88

GENERIC MARKING DIAGRAM*



A= Assembly LocationY= YearWW= Work WeekG= Pb-Free Packagexxxxxx= Device CodeKA= Polarity Designator

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " •", may or may not be present.

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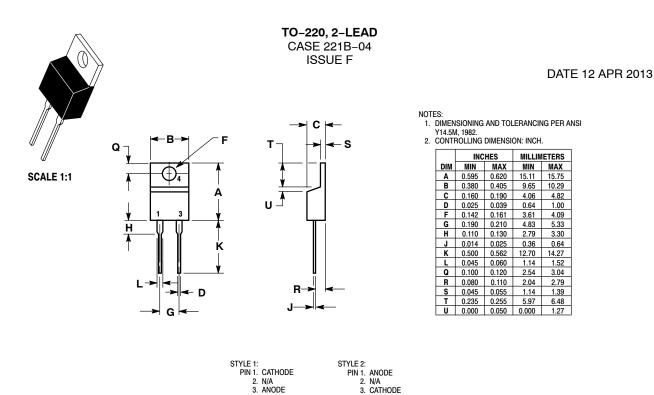
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PAGE 2 OF 2

ISSUE	REVISION	DATE
A	ADDED 2-LEAD TO PACKAGE DESCRIPTION. UPDATED MIN & MAX VALUES FOR SEVERAL DIMENSIONS. ADDED MARKING DIAGRAM. REQ. BY M. SCHAGER.	21 JAN 2008

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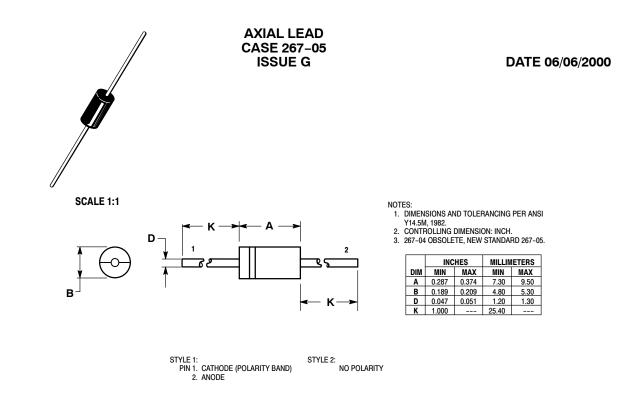
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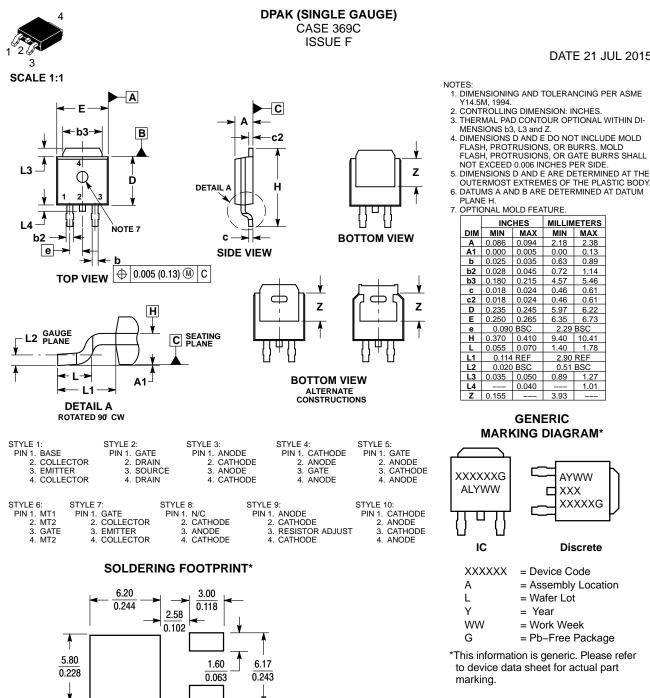




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*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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 $\left(\frac{\text{mm}}{\text{inches}}\right)$

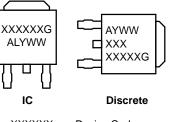
SCALE 3:1

DATE 21 JUL 2015

- 3. THERMAL PAD CONTOUR OPTIONAL WITHIN DI-MENSIONS b3, L3 and Z. 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD
- FLASH, PROTRUSIONS, OR BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL
- NOT EXCEED 0.006 INCHES PER SIDE. 5. DIMENSIONS D AND E ARE DETERMINED AT THE

OPTIONAL MOLD FEATURE.					
	INCHES		MILLIMETER		
DIM	MIN	MAX	MIN	MAX	
Α	0.086	0.094	2.18	2.38	
A1	0.000	0.005	0.00	0.13	
b	0.025	0.035	0.63	0.89	
b2	0.028	0.045	0.72	1.14	
b3	0.180	0.215	4.57	5.46	
С	0.018	0.024	0.46	0.61	
c2	0.018	0.024	0.46	0.61	
D	0.235	0.245	5.97	6.22	
Е	0.250	0.265	6.35	6.73	
е	0.090	BSC	2.29 BSC		
н	0.370	0.410	9.40	10.41	
L	0.055	0.070	1.40	1.78	
L1	0.114	0.114 REF		REF	
L2	0.020	BSC	0.51	BSC	
L3	0.035	0.050	0.89	1.27	
L4		0.040		1.01	
Z	0.155		3.93		

MARKING DIAGRAM*



XXXXXX	= Device Code
A	= Assembly Location
L	= Wafer Lot
Y	= Year
WW	= Work Week
G	= Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part





PAGE 2 OF 2

ISSUE	REVISION	DATE
0	RELEASED FOR PRODUCTION. REQ. BY L. GAN	24 SEP 2001
А	ADDED STYLE 8. REQ. BY S. ALLEN.	06 AUG 2008
В	ADDED STYLE 9. REQ. BY D. WARNER.	16 JAN 2009
С	ADDED STYLE 10. REQ. BY S. ALLEN.	09 JUN 2009
D	RELABELED DRAWING TO JEDEC STANDARDS. ADDED SIDE VIEW DETAIL A. CORRECTED MARKING INFORMATION. REQ. BY D. TRUHITTE.	29 JUN 2010
E	ADDED ALTERNATE CONSTRUCTION BOTTOM VIEW. MODIFIED DIMENSIONS b2 AND L1. CORRECTED MARKING DIAGRAM FOR DISCRETE. REQ. BY I. CAM-BALIZA.	06 FEB 2014
F	ADDED SECOND ALTERNATE CONSTRUCTION BOTTOM VIEW. REQ. BY K. MUSTAFA.	21 JUL 2015

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